SCOPE:

This specification applies to the Pb Free high current type SMD inductors for

MSI-800608V-SERIES-

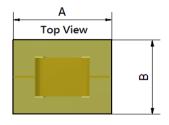
Warn: This product series can't be used in synchronous rectification circuit that is over 24V.

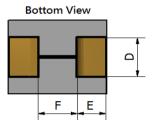
PRODUCT INDENTIFICATION

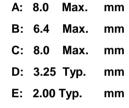
MSI-800608V-R12 K-E

- (1) (2
- 3 4 5
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **(4) Tolerance Code**
- **⑤ Inner Control Code**

(1) SHAPES AND DIMENSIONS

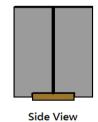






F: 3.10 Typ.





Note: Standard of the printing area, parts of the surface are the qualified Marking non-directional printing limit

mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

Isat1: WK3255BQ+ WK3265B (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range -40° C \sim $+125^{\circ}$ C (Including self temp. rise)

(3)-2 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current			Marking	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)	Isat 1(A)	Isat 2(A)	Isat 3(A)	Irms(A)	Warking
MSI-800608V-R12□-E	0.120	K,L,M	100kHz/1.0V	0.18±5%	70	61	55	57	R12
MSI-800608V-R15∐-E	0.150	K,L,M	100kHz/1.0V	0.18±5%	52	48	44	57	R15

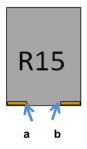
※ ☐ specify the inductance tolerance,K(±10%),L(±15%),M(±20%)

※ Isat 1: Based on inductance change (△L/Lo: drop 20% Typ.)@ ambient temp. 25℃
※ Isat 2: Based on inductance change (△L/Lo: drop 20% Typ.)@ ambient temp. 100℃
※ Isat 3: Based on inductance change (△L/Lo: drop 20% Typ.)@ ambient temp. 125℃

Irms: Based on temperature rise ($\triangle T$: 40°C TYP.) Rated DC Current: The less value which is lsat 1 or Irms.

RDC TEST POINT

The nominal DCR is measured from point a to point b.



(4) RELIABILITY TEST METHOD

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Temperature	∆L/L20℃≦±10%	The test shall be performed after the sample has stabilized in				
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value				
		calculated based on the value applicable in a normal				
		temperature and narmal humidity shall be △L/L20°C ≦±10%.				

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	\Box				
		R5 45±2 45±2				
		10 20 R340				
		PRESSURE ROD figure-1				



MECHANICAL

TEST ITEM	SPECIFICATION						
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board					
		and when a vibration having an amplitude of 1.52mm and a frequency of from 10 to 55Hz/1 minute repeated should					
	There shall be						
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.					
	damage.	(A total of 6 hours)					
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated					
-	More than 90%	over the whole of the sample before hard, the sample shall					
		then be preheated for about 2 minutes in a temperature of					
		130∼150℃ and after it has been immersed to a depth 0.5mm					
		below for 3±0.2 seconds fully in molten solder M705 with					
		a temperature of 245±5℃.					
		More than 90% of the electrode sections shall be couered with new solder smoothly when the sample is taken out of the solder bath.					
Resistance to	There shall be	Temperature profile of reflow soldering					
Soldering heat	no damage or	soldering					
(reflow soldering)	problems.	(Peak temperature 260±3°C 10 sec) Pre-heating Slow cooling (Stored at room					
		agr. 250 —					
		□ 200					
		(230 ⁺⁰ °C) Pre-heating (230 ⁺⁰ °C)					
		Slow cooling					
		1 / 1 remperature)					
		50 /					
		10					
		2 min sec. 2 min. or more					
		The specimen shall be passed through the reflow oven with the					
		condition shown in the above profile for 1 time.					
		The specimen shall be stored at standard atmospheric conditions					
		for 1 hour, after which the measurement shall be made.					



ENVIROMENT CHARACTERISTICS

TEST ITEM	SPECIFICATION							
High temperature	△L/Lo≦±5% The sample shall be left for 96±4 hours in an atmospere with							
storage		a tempe	rature	re of 125℃ and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the						
	no mechanical sample has been left in a normal temperature a							
	damage.	humidity for 1 hour.						
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with						
storage		a temperature of -40±3℃.						
	There shall be	Upon completion of the test, the measurement shall be made						
	no mechanical	after the	samp	ole has been left in a no	ormal temperature and	I		
	damage.	normal humidity for 1 hour.						
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown						
temperature		in the table 2 below and then it shall be subjected to standard						
	There shall be	stmospheric conditions for 1 hour, after which measurement						
	no other dama-	r dama- shall be made.						
	ge of problems							
		table 2						
				Temperature	Duration			
			1	-40±3℃	30 min.			
				(Themostat No.1)				
		2	Standard	No.1→No.2				
				atmospheric				
		3	3	+125±2℃	30 min.			
				(Themostat No.2)				
			4	Standard	No.2→No.1			
				atmospheric				
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of						
		40±2℃ and a humidity(RH) of 90∼95%.						
	There shall be	Upon completion of the test, the measurement shall be made						
	no mechanical	after the	samp	ole has been left in a normal temperature and				
	damage.	normal humidity more than 1 hour.						
Test conditions :								
	nnia shall ha raflow	soldered	d onto	the printed circuit boa	rd in every test			

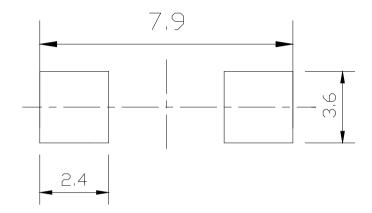


(5) LAND DIMENSION (Ref.)

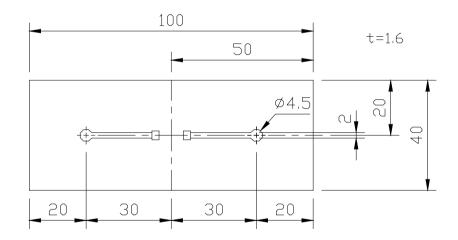
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN)



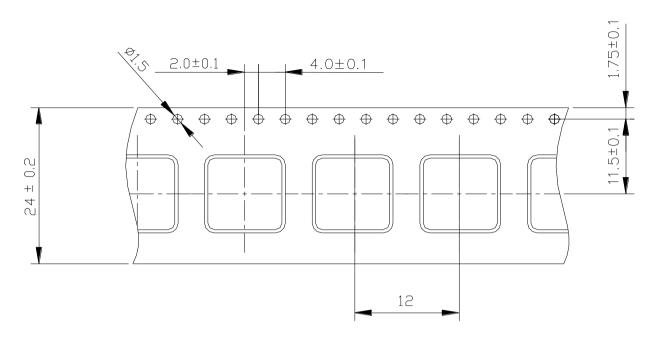
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



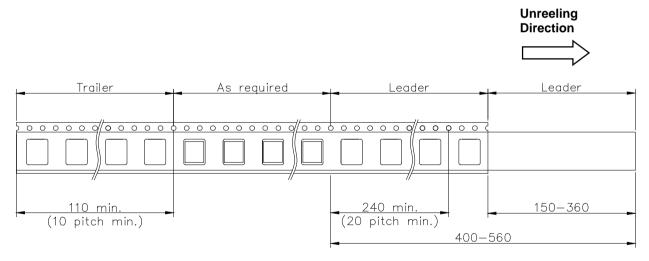


(6) PACKAGING

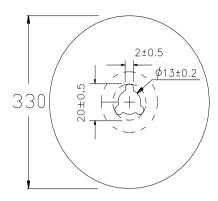
(6)-1 CARRIER TAPE DIMENSIONS (mm)



(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

500 pcs/Reel

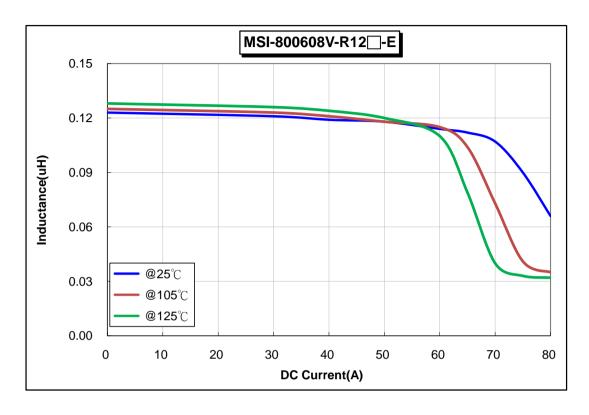
The products are packaged so that no damage will be sustained.

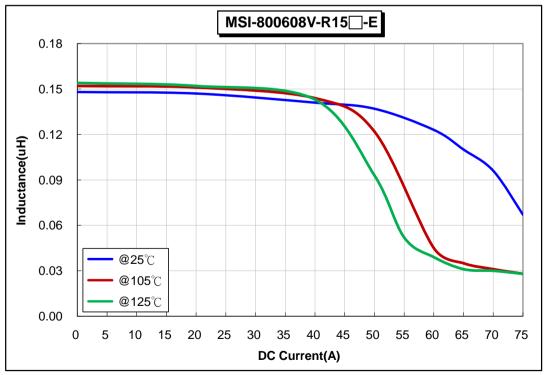
Please note that the contents may change without any prior notice due to reasons such as upgrading.



TYPICAL ELECTRICAL CHARACTERISTICS

INDUCTANCE vs. DC CURRENT@100kHz/1.0V







TYPICAL ELECTRICAL CHARACTERISTICS

Temperature Rise vs. DC Current

